

# UCC21220EVM-009

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#### 1 Introduction

The UCC21220EVM-009 device is designed for evaluation of the UCC21220 family of devices, with a 4-A source and 6-A sink peak current for driving Si MOSFETs, IGBTs, and GaN FETs. Developed for high voltage applications where isolation and reliability are required, the UCC21220 device delivers reinforced isolation of 3-kV<sub>RMS</sub> and a surge immunity tested up to 7.8-kV, with a common mode transient immunity (CMTI) greater than 100 V/ns. The device has an impressive propagation delay of 25 ns and the tightest channel-to-channel delay matching in the industry of less than 5 ns, which enables high-switching frequency, high-power density, and efficiency.

The flexible, universal capability of the UCC21220 device, with up to 5-V VCCI and 18-V VDDA and VDDB, allows it to be used as a low-side, high-side, high-side/low-side, or half-bridge driver with dual PWM input or single PWM input. With its integrated components, advanced protection features (UVLO, enable and disable), and optimized switching performances, the UCC21220 device enables designers to build smaller, more robust designs for enterprise, telecom, automotive, and industrial applications, allowing for faster time to market.

The UCC21220EVM-009 can also be used for evaluation of pin-to-pin compatible drivers with dead time control such as the UCC21222, with footprints for a surface mount potentiometer and noise reduction capacitor.

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### 2 Description

The UCC21220EVM-009 evaluation board has independent connection points for VCCI, VDDA, and VDDB supplies, including separate ground points. Three-position headers with jumpers for all the key input signals, such as PWM inputs (INA, INB, or PWM) and the disable function (DIS), let designers easily evaluate different protection functions. A variety of testing points support most of the key-feature probing of the UCC21220 device. Moreover, the PCB layout is not only optimized with minimized loop area in each gate driver loop and power supply loop with bypassing capacitors, but it also supports high voltage testing between the primary side and secondary side, with a 40-mil PCB board cutout. Importantly, the creepage distance between two output channels is maximized with a TO252-2 (DPAK) bootstrap diode, which facilitates high-voltage, half-bridge testing for a wide variety of power converter topologies. For detailed device information, see the UCC21220 4-A/6-A, Dual Channel Isolated Gate Driver data sheet and Isolated Gate Driver Solutions, from TI.

## 2.1 Features

- Evaluation module for UCC21220 and other pin-to-pin compatible drivers in SOIC-16 (D) package
- 3-V to 5-V VCCI power supply range, with up to 18-V VDDA/VDDB power supply range
- 4-A source and 6-A sink current capability
- 3-kV<sub>RMS</sub> isolation for 1 minute per UL 1577
- TTL/CMOS compatible inputs
- 3-position header for INA, INB, and DIS pins
- Optional footprints for dead time potentiometer, capacitor, and 3-position header
- PCB layout optimized for power supply bypassing capacitors, gate driver loop
- PCB board cutout facilitates high-voltage isolation test between primary side and secondary side
- Maximized creepage distance between two output channels
- Support half-bridge test with MOSFETs, IGBTs, and SiC MOSFETs, with connection to external power stage
- Testing points allow probing all the key pins of the UCC21220 device and other SOIC-16 isolated driver parts

Description



Description

#### 2.2 I/O Description

Table 1 lists the test points and jumpers.

| Pins | Description  |
|------|--|
| TP1  | Primary supply positive input  |
| TP2  | Primary supply negative input  |
| TP3  | VCC measurement point (main capacitor)                                   |
| TP4  | VCC measurement point (IC pins)  |
| TP5  | INA negative input (input side GND)                                      |
| TP6  | INB negative input (input side GND)                                      |
| TP7  | INA positive input   |
| TP8  | INB positive input   |
| TP9  | INA measurement point (IC pins)  |
| TP10 | INB measurement point (IC pins)  |
| TP11 | Input side GND (IC pins)   |
| TP12 | Disable pin input/measurement point                                      |
| TP13 | Dead time programming pin input/measurement point <sup>(1)</sup>         |
| TP14 | VDDA measurement point (IC pins)   |
| TP15 | VSSA measurement point (IC pins)   |
| TP16 | A-channel supply positive input  |
| TP17 | A-channel output, measured after gate drive resistor                     |
| TP18 | A-channel supply negative input  |
| TP19 | VDDB measurement point (IC pins)   |
| TP20 | VSSB measurement point (IC pins)   |
| TP21 | B-channel supply positive input  |
| TP22 | B-channel output, measured after gate drive resistor                     |
| TP23 | B-channel supply negative input  |
| J1-1 | Connected to VCCI  |
| J1-2 | Connected to INA   |
| J1-3 | Connected to GND   |
| J2-1 | Connected to VCCI  |
| J2-2 | Connected to INB   |
| J2-3 | Connected to GND   |
| J3-3 | Connected to VCCI  |
| J3-2 | Connected to disable pin   |
| J3-3 | Connected to GND   |
| J4-1 | Connected to VCCI  |
| J4-2 | Dead time programming pin <sup>(1)</sup>                                 |
| J4-3 | Connected to optional dead time programming potentiometer <sup>(1)</sup> |

#### Table 1. Test Points and Jumpers

<sup>(1)</sup> The UCC21220 device does not have dead time control. Pin 6 of the UCC21220 is not connected internally. J4 header, and footprints for optional trimmer potentiometer and dead time capacitor, are included for other pin-to-pin compatible isolated drivers with dead time control.

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## 2.3 Jumpers (Shunt) Setting

Table 2 lists the jumper settings.

| Header             |          | Jumper Setting Options   | Factory Setting |
|--------------------|----------|--|-----------------|
| J1                 | Option A | Jumper not installed, INA provided by external signal and this pin is low by default if left open  | <b>.</b>        |
|                    | Option B | Jumper on J1-2 and J1-3 sets INA low   | Option A        |
|                    | Option C | Jumper on J1-2 and J1-1 sets INA high  |                 |
|                    | Option A | Jumper not installed, INB provided by external signal, and this pin is low by default if left open |                 |
| J2                 | Option B | Jumper on J2-2 and J2-3 sets INB low   | Option A        |
|                    | Option C | Jumper on J2-2 and J2-1 sets INB high  |                 |
|                    | Option A | Jumper not installed   |                 |
| J3                 | Option B | Jumper on J3-2 and J3-3 sets DIS low (part is enabled)   | Option C        |
|                    | Option C | Jumper on J3-2 and J3-1 sets DIS high (part is disabled)   |                 |
|                    | Option A | Jumper not installed   |                 |
| .14 <sup>(1)</sup> | Option B | Jumper on J4-2 and J4-1 sets pin 6 high.   | Option B        |
|                    | Option C | Jumper on J4-2 and J4-3 connects pin 6 to the optional trimmer potentiometer.                      |                 |

#### Table 2. Jumpers Setting

<sup>(1)</sup> The UCC21220 device does not have dead time control. Pin 6 of the UCC21220 device is not connected internally. J4 header, and footprints for optional trimmer potentiometer and dead time capacitor, are included for other pin-to-pin compatible isolated drivers with dead time control.

## 3 Electrical Specifications

Table 3 lists the UCC21220EVM-009 electrical specifications.

#### Table 3. UCC21220EVM-009 Electrical Specifications

|                    | Description                             | MIN | TYP MAX | UNIT |
|--------------------|---|-----|---------|------|
| V <sub>CCI</sub>   | Primary-side power supply               | 3   | 5.5     | V    |
| $V_{DDA,} V_{DDB}$ | Driver output power supply for UCC21220 | 9.2 | 18      | V    |
| F <sub>sw</sub>    | Switching frequency                     | 0   | 10      | MHz  |
| TJ                 | Operating junction temperature range    | -40 | 130     | °C   |

Description



## 4 Test Summary

In this section, the default factory configuration for the jumper settings must be changed to enable the part as per Figure 1. Different jumper settings, PWM signal input options, and voltage source settings are described in Section 2 and Section 3.

## 4.1 Equipment

## 4.1.1 Power Supplies

Three DC power supplies with voltage/current above 18 V and 1 A, respectively are required, for example: Agilent E3634A.

#### 4.1.2 Function Generators

One 2-channel function generator over 20 MHz is required, for example: Tektronics AFG3252.

#### 4.2 Equipment Setup

#### 4.2.1 DC Power Supply Settings

- DC power supply 1
  - Voltage setting: 5 V
  - Current limit: 0.05 A
- DC power supply 2
  - Voltage setting: 12 V
  - Current limit: 0.1 A
- DC power supply 3
  - Voltage setting: 12 V
  - Current limit: 0.1 A

#### 4.2.2 Digital Multi-Meter (DMM) Settings

- Digital multi-meter 1:
  - DC current measurement, auto-range.
- Digital multi-meter 2:
  - DC current measurement, auto-range.

#### 4.2.3 Two-Channel Function Generator Settings

Table 4 lists the 2-channel function generator settings.

#### **Table 4. Two-Channel Function Generator Settings**

|           | Mode  | Frequency | Duty   | Delay  | High     | Low  | Output<br>Impedance |        |
|-----------|-------|-----------|--------|--------|----------|------|---------------------|--------|
| Channel 1 | Pulse | Pulso     | 10 MHz | 50%    | 50% 0 ns | 33.V | 0.V                 | High 7 |
| Channel 2 |       |           | 50 %   | 500 ns | 0.0 V    | 0 V  | r nyn z             |        |

## 4.2.4 Oscilloscope Setting

Table 5 lists the oscilloscope setting.

## Table 5. Oscilloscope Settings

|           | Bandwidth        | Coupling | Termination               | Scale Settings   | Inverting |
|-----------|------------------|----------|---------------------------|------------------|-----------|
| Channel 1 | 500 MHz or above | DC       | 1 M $\Omega$ or automatic | 10× or automatic | Off       |
| Channel 2 |                  |          |                           |                  |           |

## 4.2.5 Jumper (Shunt) Settings

The jumper on header J3 must be installed by the user between pins J3-2 and J3-3 to enable the part for testing. The jumper on header J4 may be placed in any position or removed (see Figure 1).



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**Figure 1. Jumpers Installation Position** 



#### 4.2.6 Bench Setup Diagram

The current bench setup diagram includes the function generator and oscilloscope connections.

Follow this connection procedure, Figure 2 can be used as a reference.

- 1. Ensure the output of the function generator and voltage sources are disabled before connection.
- 2. Connect the function generator channel 1 to TP7 (INA) and TP5 (GND), see Figure 2.
- 3. Connect the function generator channel 2 to TP8 (INB) and TP6 (GND), see Figure 2.
- 4. Power supply 1: Connect the positive lead to TP1 (VCCIN). Connect the negative lead to TP2 (GND).
- 5. Power supply 2: Connect the positive lead to the current meter input of DMM1, and connect the current meter output of DMM1 to TP16 (VDDAIN). Connect the negative lead directly to TP18 (GNDA).
- 6. Power supply 3: Connect the positive lead to the current meter input of DMM2, and connect the current meter output of DMM2 to TP21 (VDDBIN). Connect the negative lead directly to TP23 (GNDB).
- 7. Connect the oscilloscope channel 1 probe to TP17 (V\_GA) and TP15 (GNDA). The probe loop area should be minimized.
- Connect the oscilloscope channel 2 probe to TP22 (V\_GB) and TP20 (GNDB). The probe loop area should be minimized.



Figure 2. Bench Setup Diagram and Configuration



## 5 Power Up and Power Down Procedure

## 5.1 Power Up

- 1. Before preceding with the power up test procedure, ensure that the steps in Section 4.2.6 are complete. Figure 3 can be used as a reference.
- 2. Enable power supply 1.
- 3. Enable power supplies 2 and 3. The quiescent current on DMM1 and DMM2 should be approximately 1 mA to 3 mA if everything is set correctly.
- 4. Enable the function generator outputs.
- 5. Verify that the following occurs:
  - 1. Stable pulse output appears on channel 1 and channel 2 in the oscilloscope, see Figure 3.
  - 2. Oscilloscope frequency measurement matches programmed function generator frequency.
  - 3. DMM1 and DMM2 currents should read 14 ± 2 mA under no load conditions. For more information about the operating current, see the UCC21220 4-A/6-A, Dual Channel Isolated Gate Driver data sheet.



Figure 3. Example Input and Output Waveforms (Inputs: CH1 and CH2, Outputs: CH3 and CH4)



#### Power Up and Power Down Procedure

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#### Figure 4 shows a zoomed-in view of the example input and output waveforms.

Figure 4. Example Input and Output Waveforms, Zoom In (Inputs: CH1 and CH2, Outputs: CH3 and CH4)

### 5.2 Power Down

The following lists the procedure to power down the EVM.

- 1. Disable the function generator.
- 2. Disable power supplies 2 and 3.
- 3. Disable power supply 1.
- 4. Disconnect the cables and probes.



## 6 Schematic







Layout Diagrams

## 7 Layout Diagrams



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Figure 6. Top Overlay



### Figure 7. Top Layer



Layout Diagrams



Figure 8. Bottom Layer (Flipped)



Figure 9. Bottom Overlay (Flipped)



Bill of Materials

## 8 Bill of Materials

## Table 6. UCC21220EVM-009 Bill of Materials

| QTY | Designator  | Description   | Part Number | Manufacturer      |
|-----|---|---|-------------|-------------------|
| 2   | C1, C12   | Capacitor, ceramic, 10 µF, 50 V, ± 10%, X5R, 1206                                 | -           | Any               |
| 2   | C2, C9  | Capacitor, ceramic, 1 µF, 50 V, ± 10%, X5R, 0603                                  | -           | Any               |
| 3   | C3, C8, C11   | Capacitor, ceramic, 0.22 µF, 50 V, ± 10%, X7R, 0603                               | -           | Any               |
| 1   | C6  | Capacitor, ceramic, 1000 pF, 50 V, ± 5%, C0G/NP0, 0603                            | -           | Any               |
| 4   | H1, H2, H3, H4  | Machine screw, round, no. 4 - 40 × 1/4  | -           | Any               |
| 4   | H5, H6, H7, H8  | Standoff, 0.5" L, no. 4 – 40  | -           | Any               |
| 4   | J1, J2, J3, J4  | Header, 100 mil, 3 × 1, TH  | -           | Any               |
| 1   | R1  | Resistor, 1.00 Ω, 1%, 0.125 W, 0805   | -           | Any               |
| 1   | R5  | Resistor, 2.2 Ω, 5%, 0.125 W, 0805  | -           | Any               |
| 2   | R6, R8  | Resistor, 0 Ω, 5%, 0.125 W, 0805  | -           | Any               |
| 2   | R7, R9  | Resistor, 2.2 Ω, 5%, 0.1 W, 0603  | -           | Any               |
| 2   | SH1, SH2  | Shunt, 100 mil, flash gold, black   | -           | Any               |
| 23  | TP1, TP2, TP3, TP4,<br>TP5, TP6, TP7, TP8,<br>TP9, TP10, TP11,<br>TP12, TP13, TP14,<br>TP15, TP16, TP17,<br>TP18, TP19, TP20,<br>TP21, TP22, TP23 | Test point, miniature, SMT  | _           | Any               |
| 1   | U1  | 4-A, 6-A, 3-kV <sub>RMS</sub> isolated dual-channel gate driver, D0016A (SOIC-16) | UCC21220DR  | Texas Instruments |
| 0   | C4, C5  | Capacitor, ceramic, 47 pF, 50 V, ± 1%, C0G/NP0, 0603                              | -           | Any               |
| 0   | C7  | Capacitor, ceramic, 0.01 µF, 100 V, ± 5%, X7R, 0603                               | -           | Any               |
| 0   | C10, C13  | Capacitor, ceramic, 1000 pF, 50 V, ± 5%, C0G/NP0, 0805                            | -           | Any               |
| 0   | D1  | Diode, Schottky, 600 V, 8 A, DPAK   | -           | Any               |
| 0   | R2, R3  | Resistor, 51 Ω, 5%, 0.1 W, 0603   | _           | Any               |
| 0   | R4  | Trimmer, 100 kΩ, 0.25 W, TH   | -           | Any               |



## **Revision History**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| C | Changes from A Revision (December 2017) to B Revision   |      |  |
|---|---|------|--|
| • | Added clarification about evaluating other pin-to-pin compatible drivers in the Introduction and Description sections | 2    |  |
| C | hanges from Original (November 2017) to A Revision  | Page |  |

| • | Changed Test Points and Jumpers table and added table note                          | 4  |
|---|---|----|
| • | Changed Jumper (Shunt) Settings section and Jumpers Installation Position image     | 7  |
| • | Changed Bench Setup Diagram section and Bench Setup Diagram and Configuration image | 8  |
|   | Changed Schematic image   | 11 |
|   | Changed BOM table   | 14 |
|   |   |    |

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